

## DECLARATION

SOLE/JOINT INVENTOR  
ORIGINAL/SUBSTITUTE/CIP

As a below named inventor, I hereby declare that: my residence, post office address, and citizenship are as stated below next to my name. I believe I am the original, first, and sole inventor (if only one name is listed below) or a joint inventor (if plural inventors are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled: **SOFTWARE DELIVERY SYSTEM** as described in the specification attached.

I hereby state that I have reviewed and understand the contents of the above identified specification, including the claims, as amended by any amendment referred to above; that I do not know and do not believe the same was ever known or used in the United States of America before my or our invention thereof, or patented or described in any printed publication in any country before my or our invention thereof or more than one year prior to this application; that the invention has not been patented or made the subject of an inventor's certificate issued before the date of this application in any country foreign to the United States of America on an application filed by me or my legal representative or assigns more than twelve months prior to this application; and that I acknowledge the duty to disclose information of which I am aware which is material to the examination of this application in accordance with Title 37, Code of Federal Regulations § 1.56(a). Such information is material when it is not cumulative to information already of record or being made of record in the application, and

- (1) it establishes, by itself or in combination with other information, a prima facie case of unpatentability of a claim; or  
(2) it refutes, or is inconsistent with, a position the applicant has taken or may take in:


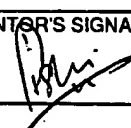
- (i) opposing an argument of unpatentability relied on by the Office, or  
(ii) asserting an argument of patentability.

I hereby claim foreign priority benefits under Title 35, United States Code § 119 of any foreign application(s) for patent or inventor's certificates listed below and have also identified below any foreign application(s) having a filing date before that of the application(s) on which priority is claimed:

COUNTRY	APPLICATION NUMBER	DATE OF FILING	PRIORITY CLAIMED UNDER 35 USC 119
Singapore	9904743-3	23 September 1999	<input checked="" type="checkbox"/> YES <input type="checkbox"/> NO

I hereby claim the benefit under Title 35 United States Code § 120 of any United States application(s) listed below and, insofar as any subject matter of any claim of this application is not disclosed in the prior United States Application, I acknowledge the duty to disclose material information as defined in Title 37, Code of Federal Regulations § 1.56(a) which occurred between the filing date of the prior application and the national PCT international filing date of this application:

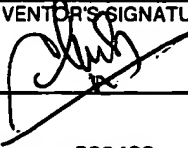

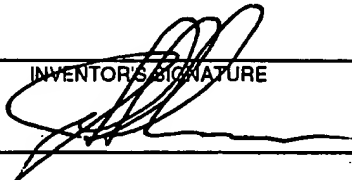
I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

FULL NAME OF SOLE OR FIRST INVENTOR	INVENTOR'S SIGNATURE	DATE
TOH, Ker Sze		2/11/99
RESIDENCE		CITIZENSHIP
Blk 207 #09-10 Choa Chu Kang Central, Singapore 680207		Singapore
POST OFFICE ADDRESS		
SAME AS ABOVE		
FULL NAME OF SOLE OR FIRST INVENTOR	INVENTOR'S SIGNATURE	DATE
LIM, Lay Sie		2 Nov 1999
RESIDENCE		CITIZENSHIP
Blk 227 Jurong East St 21, #14-825. Singapore 600227		Singapore
POST OFFICE ADDRESS		
SAME AS ABOVE		

See dec. granting pat. to  
change order of inventors

DATE ESTABLISHED

00470-250E3460

FULL NAME OF SOLE OR FIRST INVENTOR <b>POON, Chee Seng</b>	INVENTOR'S SIGNATURE 	DATE <b>11/3/98</b>
RESIDENCE <b>Blk 423 Ang Mo Kio Ave 3, #11-2470, Singapore 560423</b>		CITIZENSHIP <b>Malaysia</b>
POST OFFICE ADDRESS <b>SAME AS ABOVE</b>		
FULL NAME OF SOLE OR FIRST INVENTOR <b>Dwight Allan DeBacker</b>	INVENTOR'S SIGNATURE 	DATE <b>11/3/99</b>
RESIDENCE <b>Blk 20 Cairnhill Circle, #12-32 Cairnhill Court, Singapore 229769</b>		CITIZENSHIP <b>U.S.A.</b>
POST OFFICE ADDRESS <b>SAME AS ABOVE</b>		
FULL NAME OF SOLE OR FIRST INVENTOR <b>John W. Lance</b>	INVENTOR'S SIGNATURE 	DATE <b>11/2/99</b>
RESIDENCE <b>11 Unity Street, #03-03, Singapore 237995</b>		CITIZENSHIP <b>U.S.A.</b>
POST OFFICE ADDRESS <b>SAME AS ABOVE</b>		